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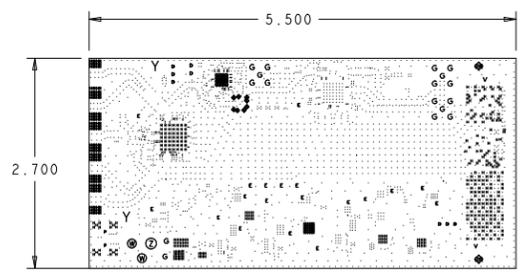
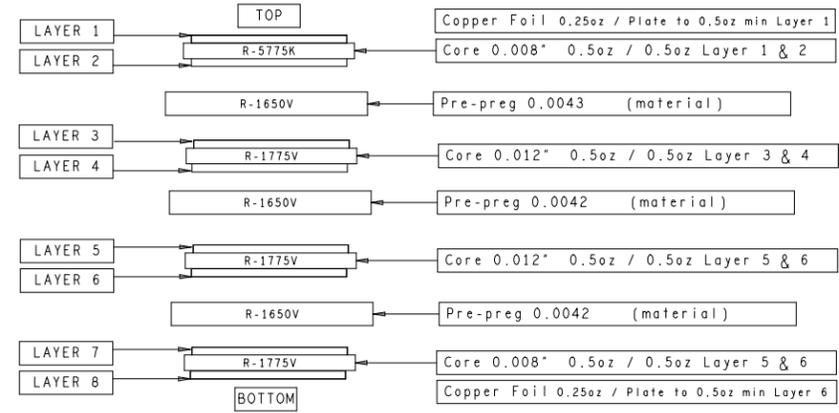
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UNLESS OTHERWISE SPECIFIED, ALL NOTES ARE APPLICABLE.

- APPLICATION DESIGN, MANUFACTURING AND INSPECTION DOCUMENTS.
IPC-2221A & IPC-2222 / DESIGN STANDARD FOR RIGID PRINTED CIRCUIT BOARDS AND RIGID PRINTED BOARD ASSEMBLIES.
IPC-6012B / QUALIFICATION AND PERFORMANCE SPECIFICATION FOR RIGID PRINTED BOARD, CLASS 2, CURRENT REVISION.
IPC-A-600G / ACCEPTABILITY OF PRINTED BOARDS, CLASS 2, CURRENT REVISION.
- VIA 8 & 10MIL SIZES APPLY AFTER PLATING. TOLERANCE TO BE $\pm .003 / - .010$.
HOLE SIZE APPLY AFTER PLATING. TOLERANCE TO BE $\pm .003$.
- REGISTRATION TOLERANCE: ARTWORK $\pm .002$.
ALL HOLE CENTERS $\pm .005$ FROM DIMENSION DATUM.
- MINIMUM COPPER WALL THICKNESS SHALL BE .001 INCH.
FOR ALL PLATED THROUGH HOLES. BREAKOUT NOT ALLOWED.
- PROCESS AND MATERIAL MUST CONFORM TO UL 796. MATERIAL MUST MEET OR EXCEED UL FLAMMABILITY RATING 94V-0.
MATERIAL: MULTI-LAYER (SEE DETAIL "A")
SEE LAYER STACKUP FOR ALL PRE-PREG & CORE THICKNESSES, COPPER OZ AND MATERIAL. FINISHED BOARD THICKNESS: $.060 \pm 10\%$
- MANUFACTURE'S UL MARKING, FLAMMABILITY RATING, LOGO AND DATE CODE TO BE PLACED IN SILKSCREEN ON BOTTOM SIDE OF THE BOARD.
- SMOBC/IMMERSION GOLD: 2 - 8 μ IN OVER 118-236 μ IN NICKEL PLATING.
- SOLDERMASK BOTH SIDES USING TAIYO (OR EQUIVALENT)
COLOR = RED (0.001 TO 002" THICK OVER METAL).
- SILKSCREEN BOTH SIDES USING WHITE NPI LEADFREE.
REGISTRATION TOLERANCE TO BE $\pm .005$.
INK IS NOT ALLOWED ON EXPOSED PLATED AREA.
- P.C. BOARD TO BE FREE OF DIRT, OIL, FINGER PRINTS, ETC.
- BOARD WARPAGE: WARP AND TWIST SHALL NOT EXCEED .007 INCH PER INCH MEASURED AT ANY LOCATION OR DIRECTION ON THE BOARD.
- BOARD MUST BE 100% ELECTRICALLY TESTED TO ENSURE NO SHORTS OR OPEN CIRCUITS AT 20V.

- ALL OUTER LAYERS USING A 19MIL TRACE WIDTH SHALL BE 50 OHMS SINGLE ENDED $\pm 10\%$.
- 9MIL TRACE WIDTH AND 6MIL SPACING ON TOP SIDE OF BOARD SHALL BE 100 OHMS DIFFERENTIAL $\pm 10\%$.
8MIL TRACE WIDTH AND 6MIL SPACING ON BOTTOM SIDE OF BOARD SHALL BE 100 OHMS DIFFERENTIAL $\pm 10\%$.
- MINIMUM COPPER CONDUCTOR WIDTH IS: 4MIL.
MINIMUM COPPER CONDUCTOR SPACING IS: 3.5MIL.
- ALL INNER LAYER UNCONNECTED PADS SHALL BE REMOVED.
- PWB MUST BE ROHS COMPLIANT AND SURVIVE LEAD FREE ASSEMBLY,
MAX REFLOW OF 260 DEGREES C (6 PASSES).
- ALL THROUGH VIAS TO BE FILLED WITH NON-CONDUCTIVE MATERIAL.
FILLED VIAS TO BE PLATED AFTER PLUGGING TO PRESENT FLAT SURFACE TO DEVICE.
NO POTHOLES.

REVISIONS				
ZONE	LTR	DESCRIPTION	DATE	APPROVED



TEXAS INSTRUMENTS, INC.
ADC32RFxxEVM
PCB REV D

DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
-	6.0	PLATED	169
-	8.0	PLATED	2223
-	10.0	PLATED	49
*	12.0	PLATED	479
*	13.0	PLATED	16
*	15.0	PLATED	8
*	38.0	PLATED	8
*	40.0	PLATED	19
⊕	62.0	PLATED	5
⊕	67.0	PLATED	12
⊕	106.0	PLATED	2
⊕	120.0	PLATED	2
Y	125.0	PLATED	2
⊕	140.0	PLATED	1
*	35.0	NON-PLATED	2
v	50.0	NON-PLATED	2

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE: FRACTIONS DECIMALS ANGLES \pm .XX \pm .01 \pm . \pm .XXX \pm .005 \pm .	CONTRACT NO.		TEXAS INSTRUMENTS INC.			
	APPROVALS	DATE	FABRICATION DRAWING ADC32RFxxEVM			
DRAWN L. NGUYEN	10-18-15	SIZE				CODE
MATERIAL	SEE NOTE 5	ENG R. PRENTICE	10-18-15	D		D
FINISH	SEE NOTE 7, 8, 9	DO NOT SCALE DRAWING		SCALE	NONE	SHEET 1 OF 1